



# PBHV9215Z-Q

150 V, 2 A PNP high-voltage low  $V_{CEsat}$  transistor

17 July 2023

Product data sheet

## 1. General description

PNP high-voltage low  $V_{CEsat}$  transistor in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBHV8215Z-Q

## 2. Features and benefits

- High voltage
- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability  $I_C$  and  $I_{CM}$
- High collector current gain  $h_{FE}$  at high  $I_C$
- Medium power SMD plastic package
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- LED driver for LED chain module
- LCD backlighting
- Automotive motor management
- Switch Mode Power Supply (SMPS)

## 4. Quick reference data

Table 1. Quick reference data

| Symbol    | Parameter                 | Conditions   | Min | Typ | Max  | Unit |
|-----------|---------------------------|--|-----|-----|------|------|
| $V_{CEO}$ | collector-emitter voltage | open base  | -   | -   | -150 | V    |
| $I_C$     | collector current         |  | -   | -   | -2   | A    |
| $h_{FE}$  | DC current gain           | $V_{CE} = -10$ V; $I_C = -100$ mA; pulsed; $t_p \leq 300$ $\mu$ s; $\delta = 0.02$ ; $T_{amb} = 25$ °C | 100 | 180 | -    |      |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline    | Graphic symbol |
|-----|--------|-------------|-----------------------|----------------|
| 1   | B      | base        | <p>SC-73 (SOT223)</p> | <p>sym028</p>  |
| 2   | C      | collector   |                       |                |
| 3   | E      | emitter     |                       |                |
| 4   | C      | collector   |                       |                |

## 6. Ordering information

Table 3. Ordering information

| Type number                 | Package |   |                        |
|-----------------------------|---------|---|------------------------|
|                             | Name    | Description   | Version                |
| <a href="#">PBHV9215Z-Q</a> | SC-73   | plastic, surface-mounted package with increased heatsink; 4 leads; 2.3 mm pitch; 6.5 mm x 3.5 mm x 1.65 mm body | <a href="#">SOT223</a> |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PBHV9215Z-Q | V9215Z       |

## 8. Limiting values

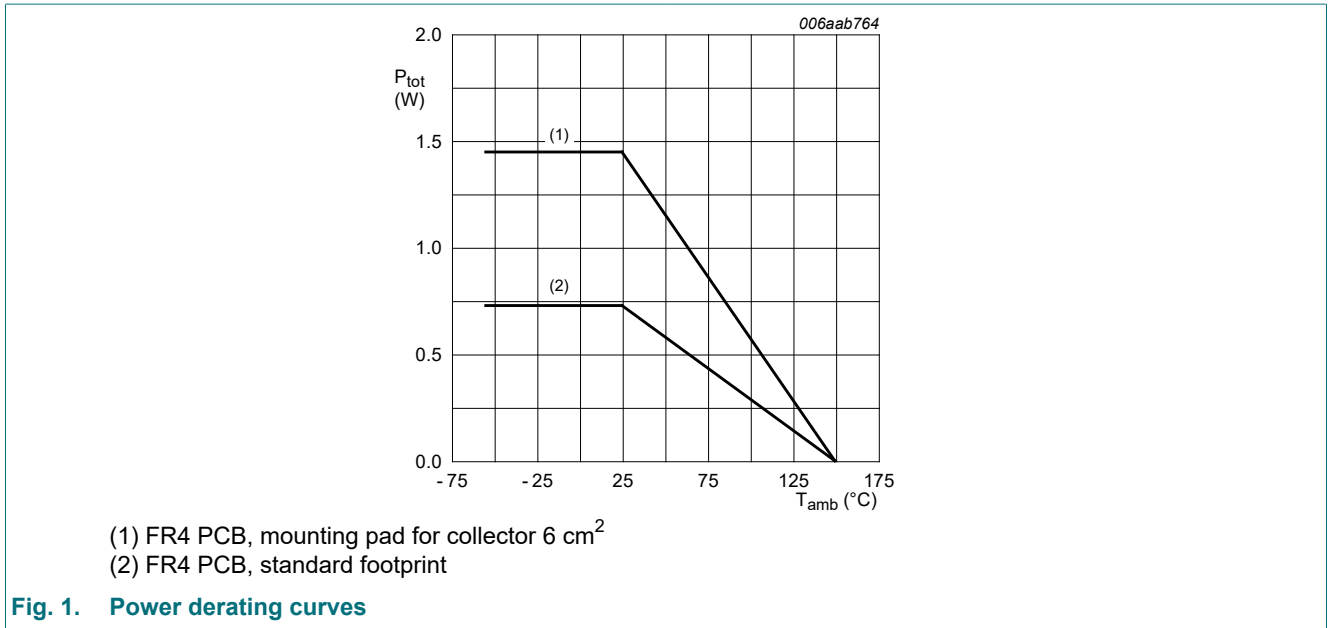
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter                 | Conditions                    |     | Min | Max  | Unit |
|-----------|---------------------------|-------------------------------|-----|-----|------|------|
| $V_{CBO}$ | collector-base voltage    | open emitter                  |     | -   | -200 | V    |
| $V_{CEO}$ | collector-emitter voltage | open base                     |     | -   | -150 | V    |
| $V_{EBO}$ | emitter-base voltage      | open collector                |     | -   | -6   | V    |
| $I_C$     | collector current         |                               |     | -   | -2   | A    |
| $I_{CM}$  | peak collector current    | single pulse; $t_p \leq 1$ ms |     | -   | -4   | A    |
| $I_{BM}$  | peak base current         |                               |     | -   | -500 | mA   |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25$ °C          | [1] | -   | 0.73 | W    |
|           |                           |                               | [2] | -   | 1.45 | W    |
| $T_j$     | junction temperature      |                               |     | -   | 150  | °C   |
| $T_{amb}$ | ambient temperature       |                               |     | -55 | 150  | °C   |
| $T_{stg}$ | storage temperature       |                               |     | -65 | 150  | °C   |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.



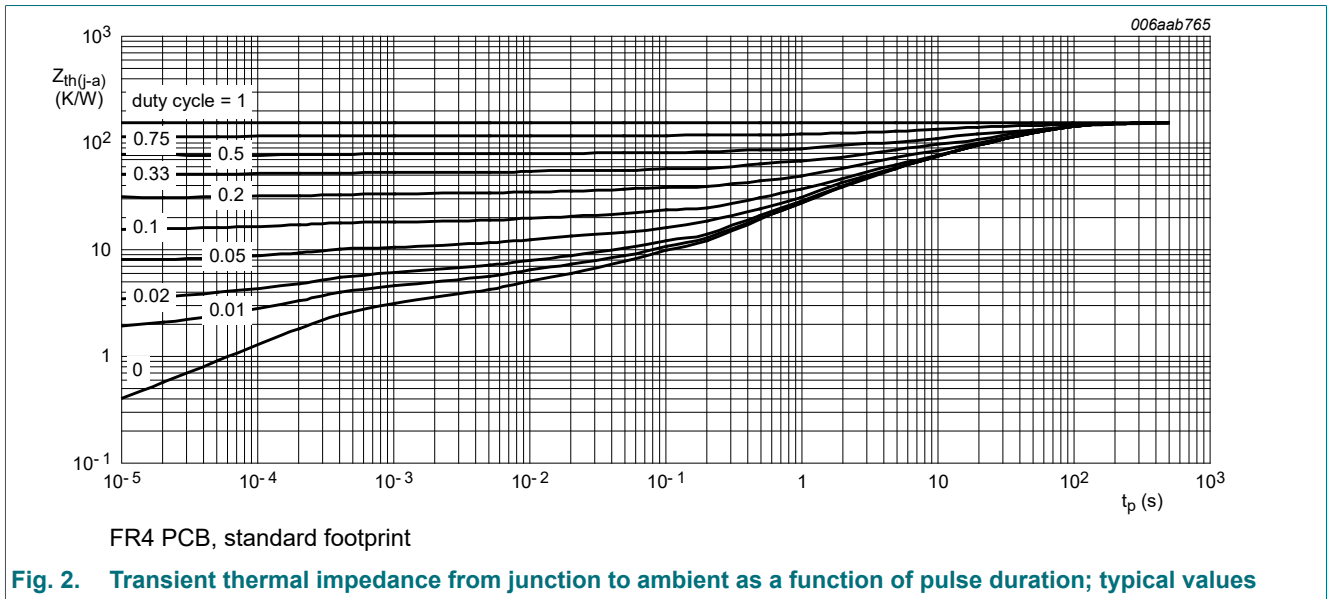
## 9. Thermal characteristics

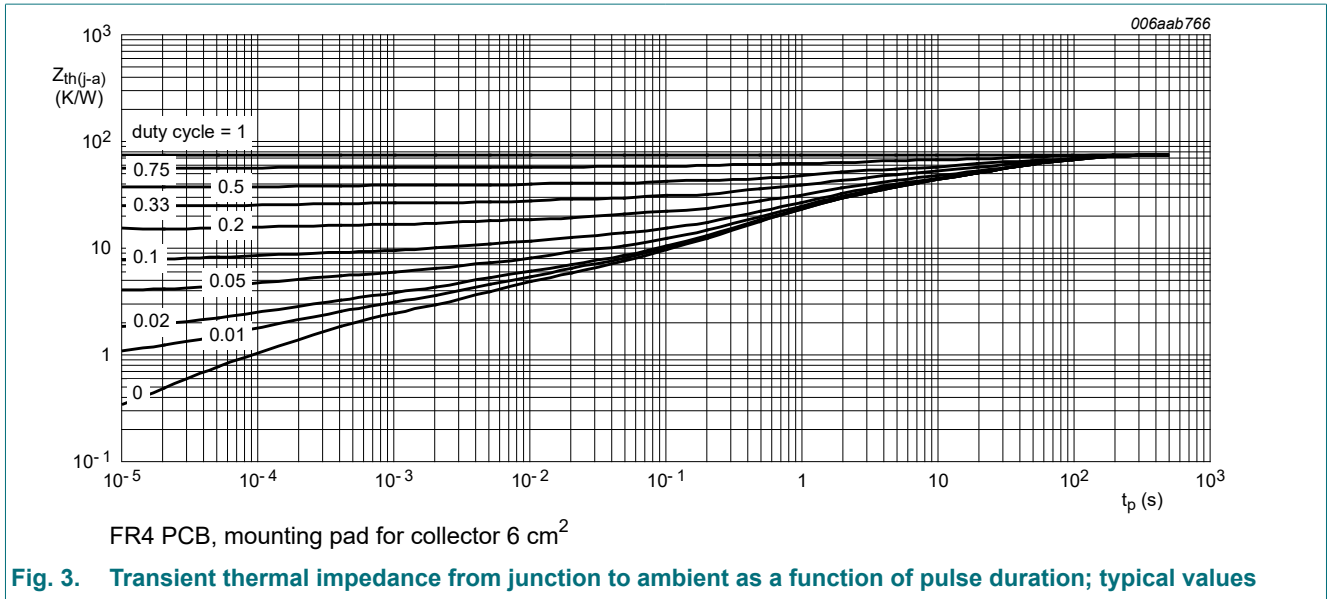
Table 6. Thermal characteristics

| Symbol                | Parameter  | Conditions  |     | Min | Typ | Max | Unit |
|-----------------------|--|-------------|-----|-----|-----|-----|------|
| R <sub>th(j-a)</sub>  | thermal resistance from junction to ambient      | in free air | [1] | -   | -   | 170 | K/W  |
|                       |  |             | [2] | -   | -   | 85  | K/W  |
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point |             |     | -   | -   | 15  | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.





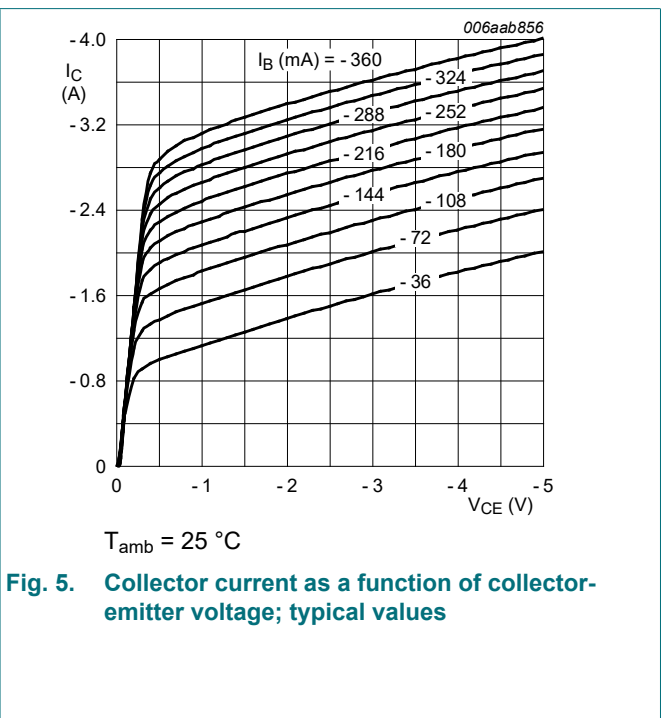
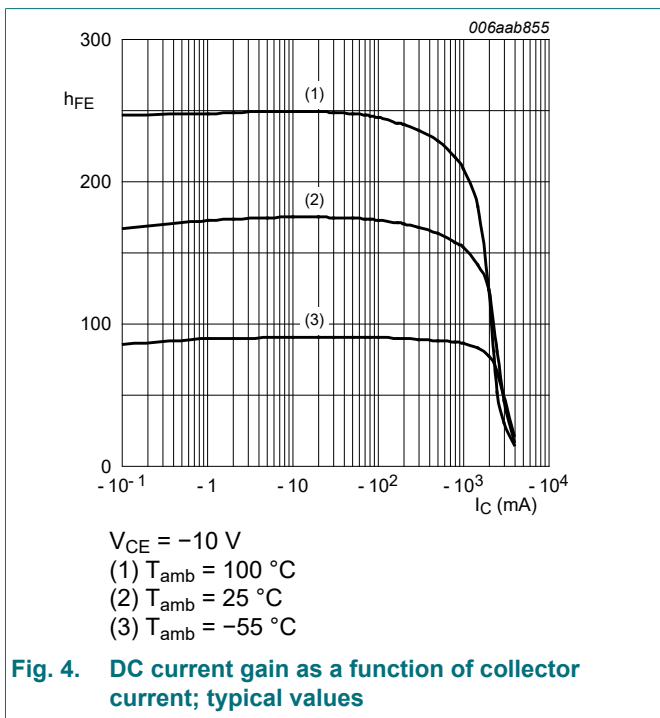
## 10. Characteristics

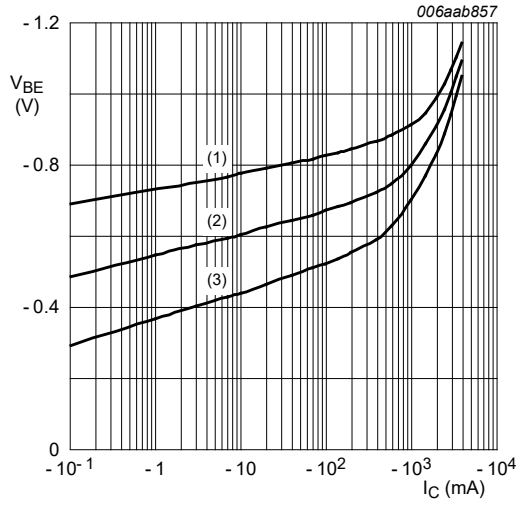
Table 7. Characteristics

| Symbol             | Parameter                               | Conditions   | Min | Typ  | Max   | Unit |
|--------------------|---|--|-----|------|-------|------|
| I <sub>CB0</sub>   | collector-base cut-off current          | V <sub>CB</sub> = -120 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C   | -   | -    | -100  | nA   |
|                    |   | V <sub>CB</sub> = -120 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C  | -   | -    | -10   | μA   |
| I <sub>EBO</sub>   | emitter-base cut-off current            | V <sub>EB</sub> = -4 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C   | -   | -    | -100  | nA   |
| I <sub>CES</sub>   | collector-emitter cut-off current       | V <sub>CE</sub> = -120 V; V <sub>BE</sub> = 0 V; T <sub>amb</sub> = 25 °C  | -   | -    | -100  | nA   |
| h <sub>FE</sub>    | DC current gain                         | V <sub>CE</sub> = -10 V; I <sub>C</sub> = -100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C | 100 | 180  | -     |      |
|                    |   | V <sub>CE</sub> = -10 V; I <sub>C</sub> = -1 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C    | 80  | 155  | -     |      |
|                    |   | V <sub>CE</sub> = -10 V; I <sub>C</sub> = -1.5 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C  | 70  | 140  | -     |      |
|                    |   | V <sub>CE</sub> = -10 V; I <sub>C</sub> = -2 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C    | 60  | 120  | -     |      |
| V <sub>CEsat</sub> | collector-emitter saturation voltage    | I <sub>C</sub> = -100 mA; I <sub>B</sub> = -20 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C | -   | -25  | -50   | mV   |
|                    |   | I <sub>C</sub> = -1 A; I <sub>B</sub> = -200 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C   | -   | -110 | -190  | mV   |
|                    |   | I <sub>C</sub> = -1.5 A; I <sub>B</sub> = -300 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C | -   | -155 | -270  | mV   |
|                    |   | I <sub>C</sub> = -2 A; I <sub>B</sub> = -400 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ = 0.02; T <sub>amb</sub> = 25 °C   | -   | -200 | -350  | mV   |
| R <sub>CEsat</sub> | collector-emitter saturation resistance | I <sub>C</sub> = -2 A; I <sub>B</sub> = -400 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C   | -   | 100  | 175   | mΩ   |
| V <sub>BEsat</sub> | base-emitter saturation voltage         |  | -   | -1   | -1.15 | V    |

150 V, 2 A PNP high-voltage low VCEsat transistor

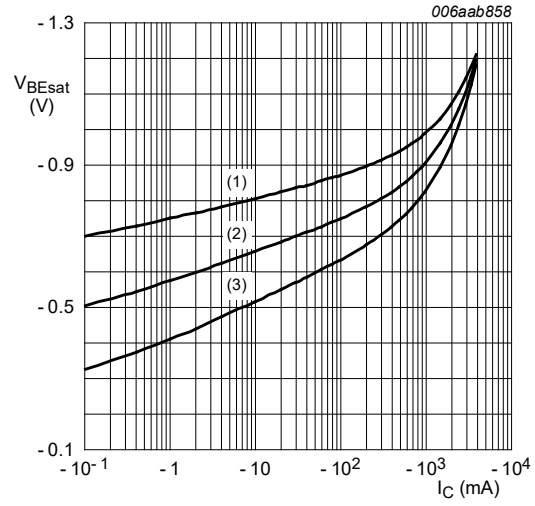
| Symbol           | Parameter             | Conditions   | Min | Typ  | Max | Unit |
|------------------|-----------------------|--|-----|------|-----|------|
| $t_d$            | delay time            | $V_{CC} = -6\text{ V}; I_C = -0.5\text{ A}; I_{B\text{on}} = -0.1\text{ A}; I_{B\text{off}} = 0.1\text{ A}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$ | -   | 20   | -   | ns   |
| $t_r$            | rise time             |  | -   | 105  | -   | ns   |
| $t_{\text{on}}$  | turn-on time          |  | -   | 125  | -   | ns   |
| $t_s$            | storage time          |  | -   | 875  | -   | ns   |
| $t_f$            | fall time             |  | -   | 150  | -   | ns   |
| $t_{\text{off}}$ | turn-off time         |  | -   | 1025 | -   | ns   |
| $f_T$            | transition frequency  | $V_{CE} = -10\text{ V}; I_C = -10\text{ mA}; f = 100\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$  | -   | 35   | -   | MHz  |
| $C_c$            | collector capacitance | $V_{CB} = -20\text{ V}; I_E = 0\text{ A}; i_e = 0\text{ A}; f = 1\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$                               | -   | 30   | -   | pF   |
| $C_e$            | emitter capacitance   | $V_{EB} = -0.5\text{ V}; I_C = 0\text{ A}; i_c = 0\text{ A}; f = 1\text{ MHz}; T_{\text{amb}} = 25\text{ }^\circ\text{C}$                              | -   | 530  | -   | pF   |





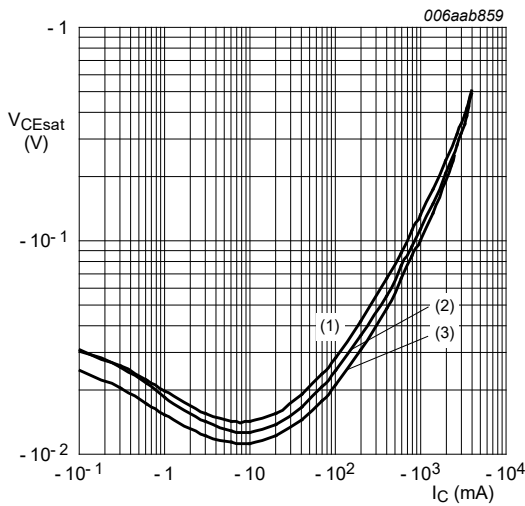
$V_{CE} = -10\text{ V}$   
 (1)  $T_{amb} = -55^\circ\text{C}$   
 (2)  $T_{amb} = 25^\circ\text{C}$   
 (3)  $T_{amb} = 100^\circ\text{C}$

**Fig. 6. Base-emitter voltage as a function of collector current; typical values**



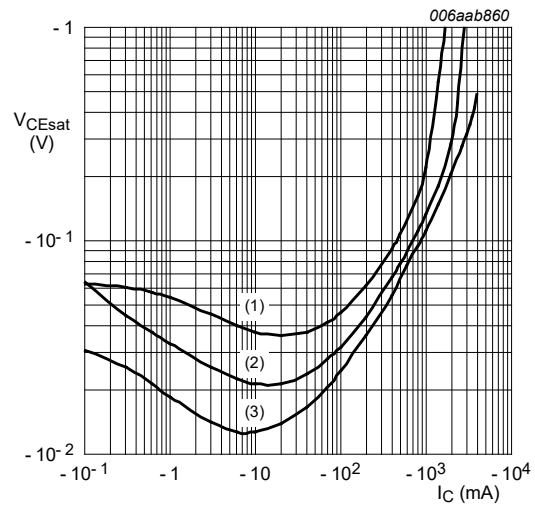
$I_C/I_B = 5$   
 (1)  $T_{amb} = -55^\circ\text{C}$   
 (2)  $T_{amb} = 25^\circ\text{C}$   
 (3)  $T_{amb} = 100^\circ\text{C}$

**Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values**



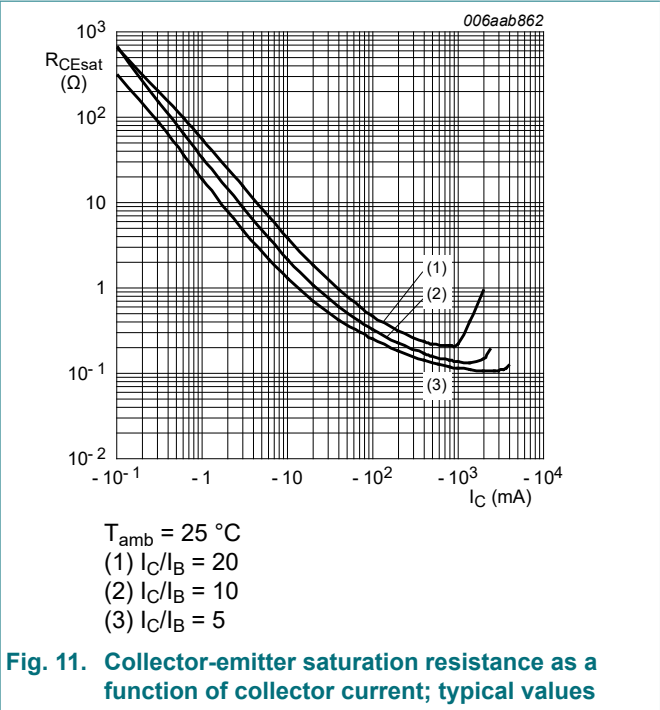
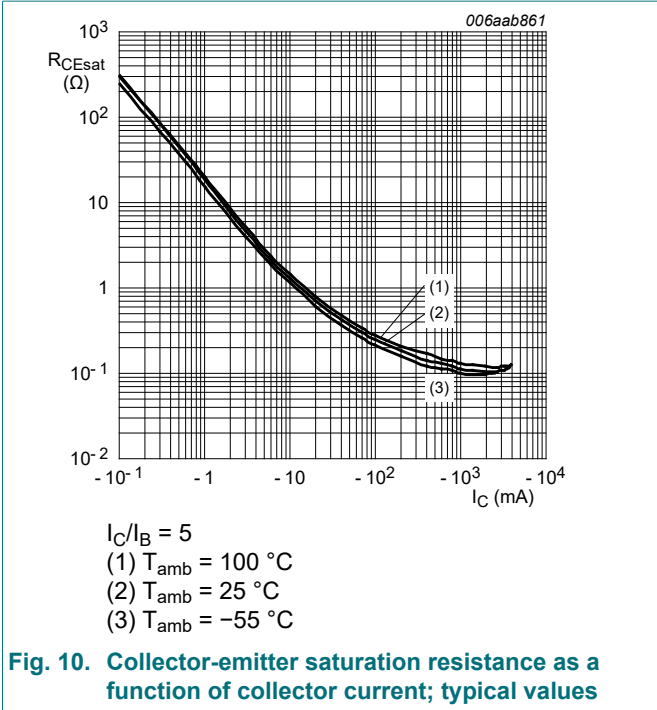
$I_C/I_B = 5$   
 (1)  $T_{amb} = 100^\circ\text{C}$   
 (2)  $T_{amb} = 25^\circ\text{C}$   
 (3)  $T_{amb} = -55^\circ\text{C}$

**Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values**

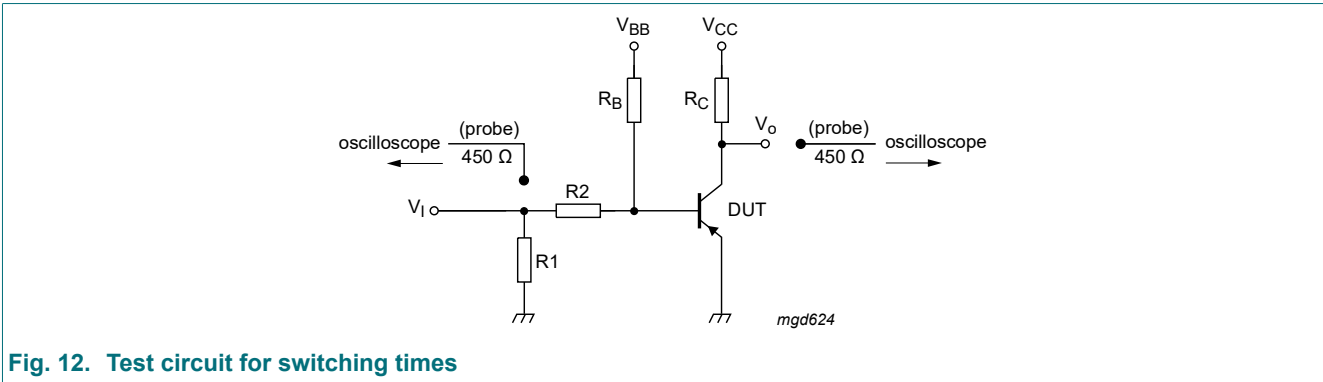


$T_{amb} = 25^\circ\text{C}$   
 (1)  $I_C/I_B = 20$   
 (2)  $I_C/I_B = 10$   
 (3)  $I_C/I_B = 5$

**Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values**



## 11. Test information



### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

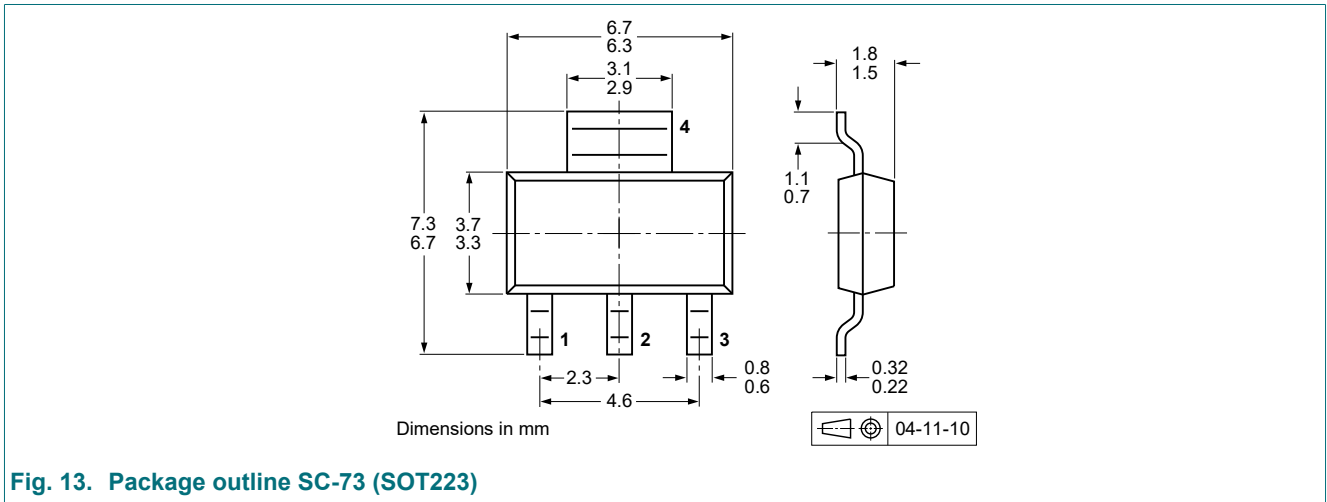


Fig. 13. Package outline SC-73 (SOT223)

## 13. Soldering

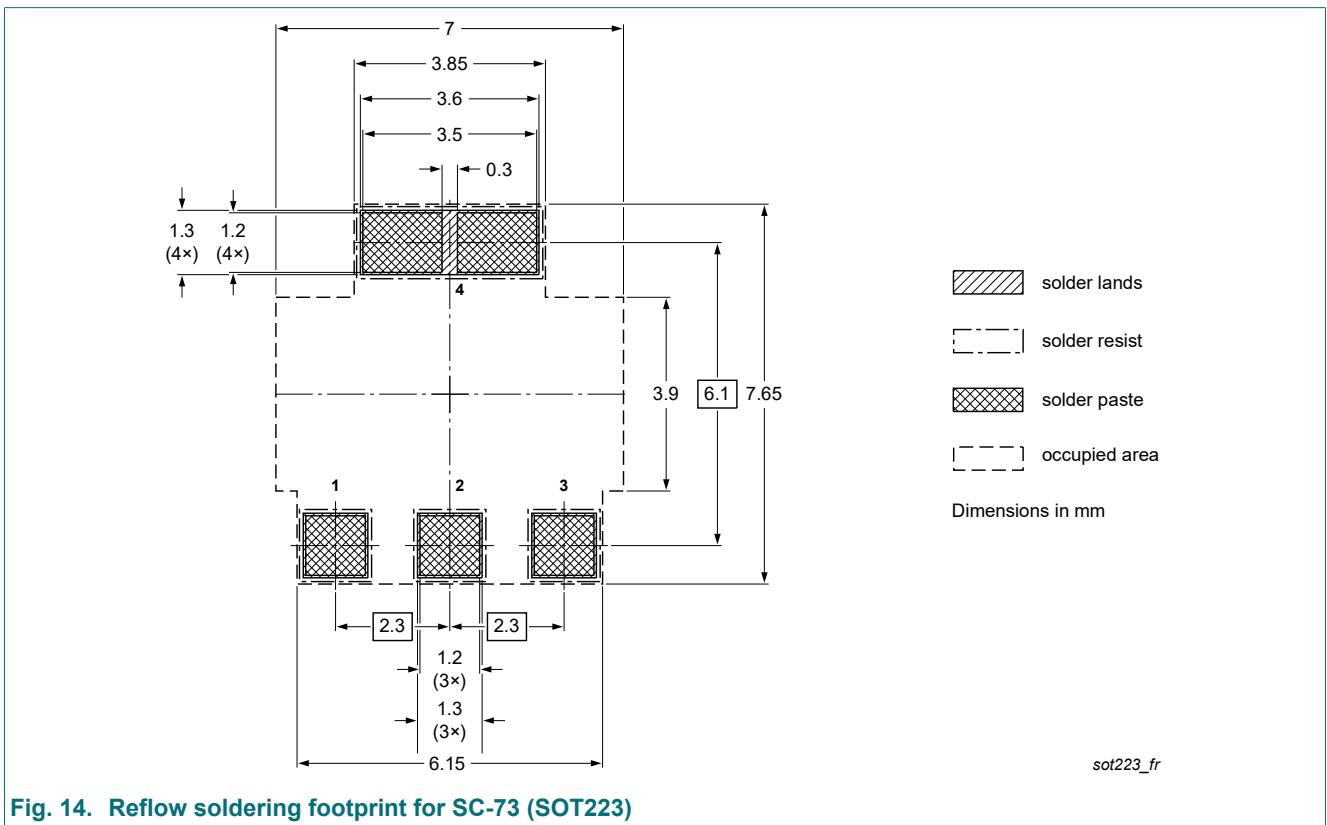


Fig. 14. Reflow soldering footprint for SC-73 (SOT223)



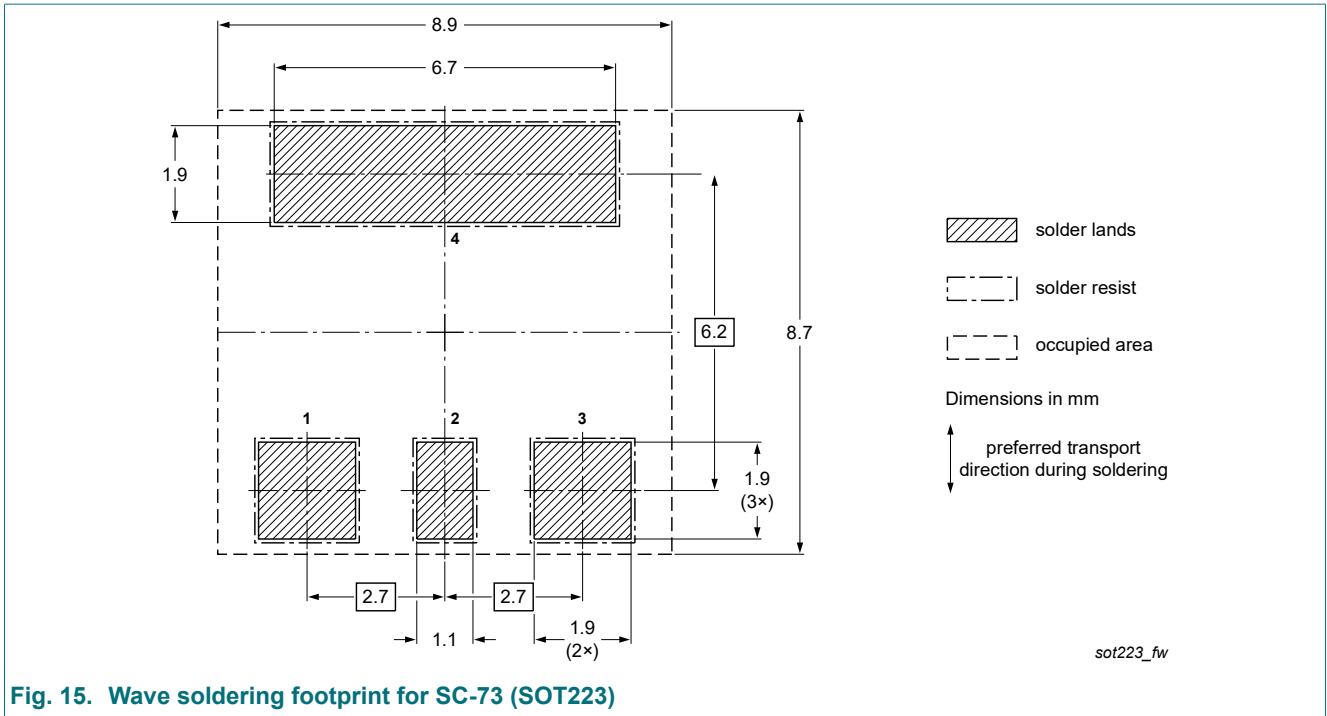


Fig. 15. Wave soldering footprint for SC-73 (SOT223)

## 14. Revision history

Table 8. Revision history

| Data sheet ID   | Release date | Data sheet status  | Change notice | Supersedes |
|-----------------|--------------|--------------------|---------------|------------|
| PBHV9215Z-Q v.1 | 20230717     | Product data sheet | -             | -          |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 17 July 2023

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